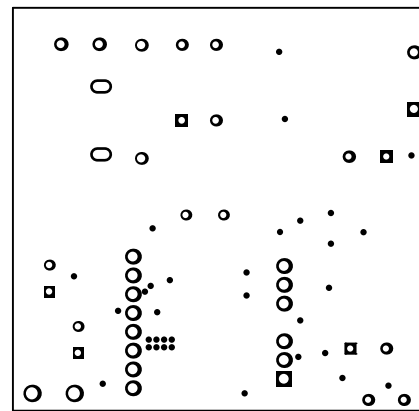
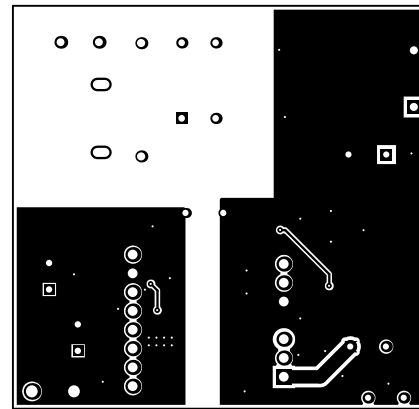


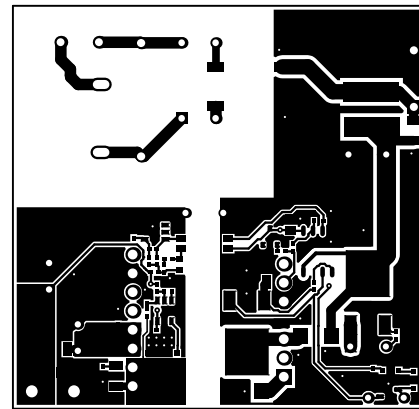
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10936	REV: C	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 8/27/2015 1:51:46 PM	TEXAS INSTRUMENTS	



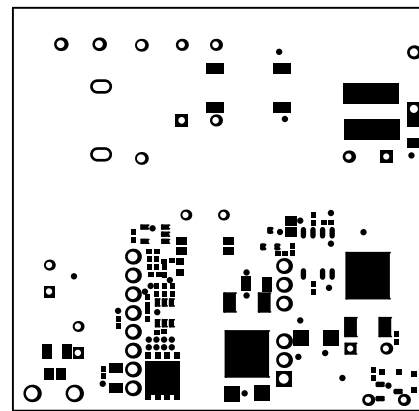
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10936	REV: C	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 8/27/2015 1:51:47 PM	TEXAS INSTRUMENTS	



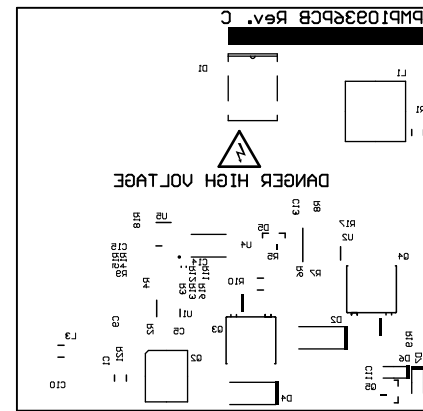
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10936	REV: C	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 8/27/2015 1:51:48 PM	TEXAS INSTRUMENTS	



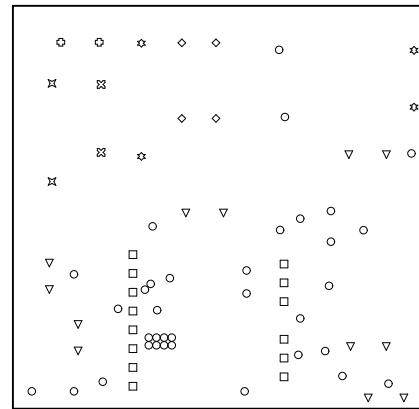
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10936	REV: C	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 8/27/2015 1:51:48 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10936	REV: C	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 8/27/2015 1:51:49 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10936	REV: C	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 8/27/2015 1:51:49 PM	TEXAS INSTRUMENTS	

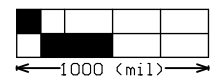
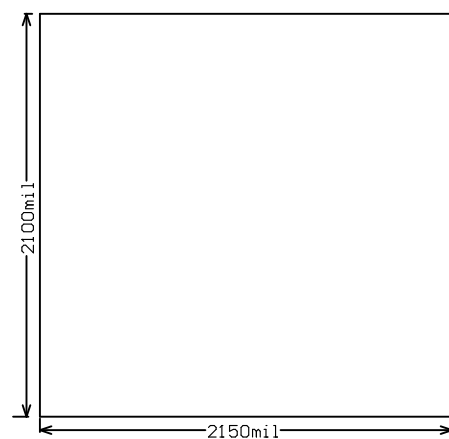


Symbol	Hit Count	Tool Size	Physical Length	Rout Path Length	Plated	Hole Type
○	33	12mil (0.305mm)			PTH	Round
▽	12	33.465mil (0.85mm)			PTH	Round
◇	4	35.433mil (0.9mm)			PTH	Round
⊙	2	41.339mil (1.05mm)			PTH	Round
✱	4	43.307mil (1.1mm)			PTH	Round
□	14	52mil (1.321mm)			PTH	Round
○	2	63mil (1.6mm)			PTH	Round
⊗	2	118.11mil (3mm)			NPTH	Round
⊗	2	47.244mil (1.2mm)	86.614mil (2.2mm)	39.37mil (1mm)	PTH	Slot
75 Total						

Slot definitions : Rout Path Length = Calculated from tool start centre position to tool end centre position.
 Physical Length = Rout Path Length + Tool Size = Slot length as defined in the PCB layout

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10936	REV: C	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 8/27/2015 1:51:50 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10936	REV: C	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 8/27/2015 1:51:51 PM	TEXAS INSTRUMENTS	

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